

Product Compliance Declaration

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Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Number 0353631360 Part Weight 0.85214G

Part Name WAFER 353631310

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
WAFER 353631310	Assembly		100	0.85214	
20 WB CONN WAFER RA	Component		62.1964	0.53	
PA66-FR(30)	Material		62.1964	0.53	
PA66	Substance		53.6444	0.457125	
Flame Retardant, ISO 1043-4 FR(30)	Substance		4.9757	0.0424	
Further Additives, not to declare	Substance	system	0.622	0.0053	
Pigment portion, not to declare	Substance	system	0.4665	0.003975	
Antimonytrioxide	Substance	1309-64-4	2.4879	0.0212	
SQ Loose Pin Plated_mm	Component		37.8036	0.32214	
Brass C2700	Material		37.6968	0.32123	
Copper	Substance	7440-50-8	25.0217	0.21322	
Lead	Substance	7439-92-1	0.0112	0.000095	
Iron	Substance	7439-89-6	0.0112	0.000095	

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Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Type CAS Num		Proportion (% Total)	Mass (Grams)	
Zinc (metal)	Substance	7440-66-6	12.6527	0.107819	
Electro Tin Plating	Material		0.0458	0.00039	
Tin	Substance	7440-31-5	0.0458	0.00039	
Electro Copper Plating	Material		0.061	0.00052	
Copper	Substance	7440-50-8	0.061	0.00052	

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Not reviewed

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

Contained Substances Exceeding Threshold

None

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HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number	0353631360								
Part Name	WAFER	353631310	(e)						
Part Information	on				Haz	zardous S	Substance	es	
Components				Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
WAFER	3536313	310		0	0	0	0	0	0
20 WB CON	N WAFER RA			0	0	0	0	0	0
SQ Loose Pi	n Plated_mm			0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	SnCu
Termination Base Alloy	Brass
Solder Alloy	SnAgCu
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Mar 24, 2021